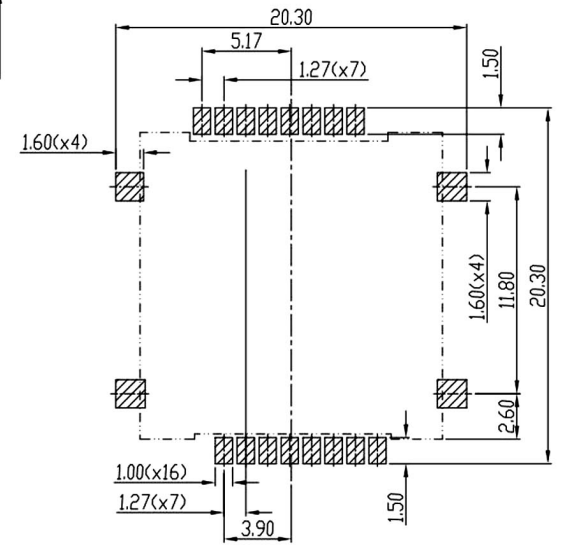


- NOTES:
- MATERIAL:
    - Housing: HI-TEMP Plastic, UL94V-0, Black;
    - Terminal: Copper alloy,
    - Shell: Stainless Steel,
  - FINISH:
    - Terminal: Au Plated on the contact area, Matte tin plated on the solder tails underplated over nickel;
    - Shell: Au plated on the solder tails underplated over nickel;
  - Electrical Performance:
    - Contact Resistance: 50mΩ Max
    - Dielectric Withstanding Voltage: 350V AC rms for 1 minut
    - Insulation Resistance: 1000 MΩ Min
  - Mechanical Performance:
    - Durability: 3000 cycles;
    - Normal force: 20gf/PIN Min;

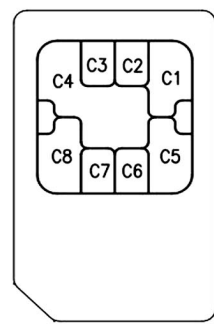


UPPER CARD



C1	C1:VCC
C2	C2:RST
C3	C3:CLK
C4	C4:RESERVED
C5	C5:GND
C6	C6:VPP
C7	C7:I/O
C8	C8:RESERVED

SIM CARD CIRCUIT



LOWER CARD



<p>RoHS Compliant</p>		<p><b>HSM</b> 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.</p>	
<p>APPD. 核准</p>		<p>TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15</p>	<p>PART NAME 品名 SIM CARD CONNECTOR 2X1 PORTS 16P SMT TYPE SELETIVE GOLD PLATING BLACK COLOR REEL PACKING ROHS</p>
<p>DWG. 製圖</p>	<p>SCALE 比例 參考</p>	<p>UNIT 單位 M M</p>	<p>PART NO. 料號 C0626-16DSBR01R</p>
<p>DATE 製表日 2018/01/18</p>	<p>PAGE 張數 1 OF 1</p>	<p>REV. 版次 A</p>	